

RoHS

COMPLIANT

N-Channel 30-V (D-S) MOSFET

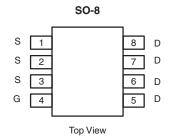
PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Typ)		
30	0.00325 at V _{GS} = 10 V	25	36		
	0.0042 at V_{GS} = 4.5 V	22	30		

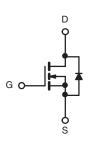
FEATURES

- Ultra Low On-Resistance Using High Density TrenchFET[®] Gen II Power MOSFET Technology
- Qg Optimized
- 100 % Rg Tested

APPLICATIONS

- Synchronous Buck Low-Side
 - Notebook
 - Server
 - Workstation
- Synchronous Rectifier, POL





Ordering Information: Si4336DY-T1 Si4336DY-T1-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ess otherwise	noted		
Parameter		Symbol	10 sec	Steady State	Unit
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V _{GS}	± 20		
	T _A = 25 °C	I _D	25	17	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		20	13	
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	70		А
Continuous Source Current (Diode Conduction) ^a		۱ _S	2.9	1.3	
Avalanche Current	L = 0.1 mH	I _{AS}	50		
	T _A = 25 °C	P _D	3.5	1.6	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.2	1	vv
Operating Junction and Storage Temperature Ran	ge	T _J , T _{stg}	- 55	to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum I wating to Anabian 12	$t \le 10 \text{ sec}$	R _{thJA}	29	35	
Maximum Junction-to-Ambient ^a	Steady State		67	80	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16	

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static			•	•	•		
Gate Threshold Voltage	V _{GS(th)}	h) $V_{DS} = V_{GS}, I_D = 250 \mu A$			3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	1	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
	IDSS	$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	30			А	
Drain-Source On-State Resistance ^a	-	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		0.0026	0.00325		
	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 22 \text{ A}$		0.0033	0.0042	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		110		S	
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.72	1.1	V	
Dynamic ^b							
Input Capacitance	C _{iss}			5600		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		860			
Reverse Transfer Capacitance	C _{rss}			415			
Total Gate Charge	Qg			36	50		
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 20 A		18		nC	
Gate-Drain Charge	Q _{gd}			10			
Gate Resistance	Rg		0.8	1.3	2.0	Ω	
Turn-On Delay Time	t _{d(on)}			24	35		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		16	25	ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ 1 A, V_{GEN} = 10 V, R_{g} = 6 Ω		90	140		
Fall Time	t _f			32	50		
Source-Drain Reverse Recovery Time t _{rr}		I _F = 2.9 A, di/dt = 100 A/μs		45	70		

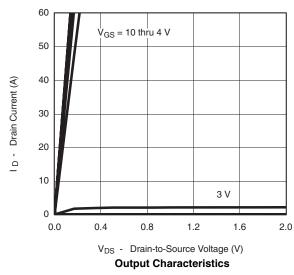
Notes:

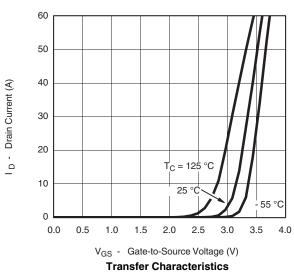
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

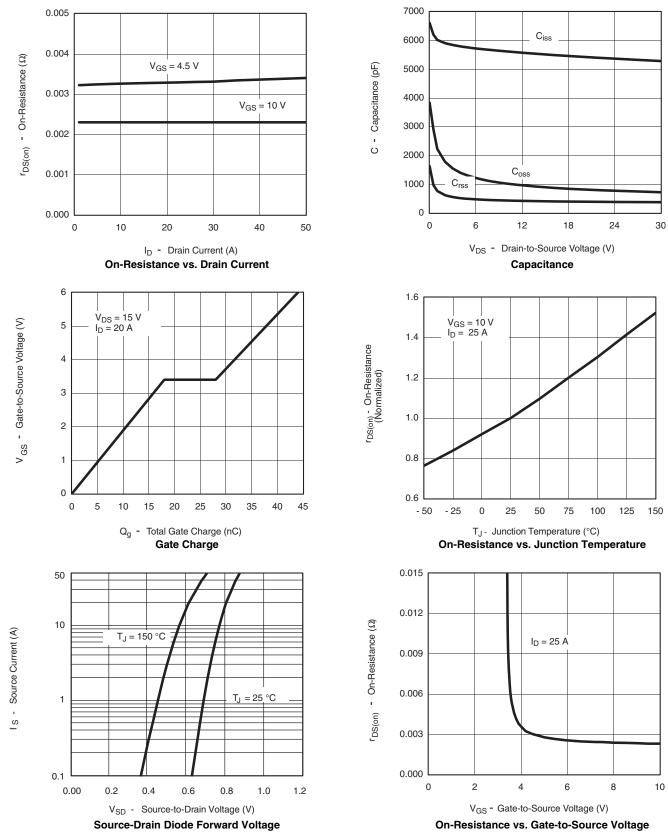




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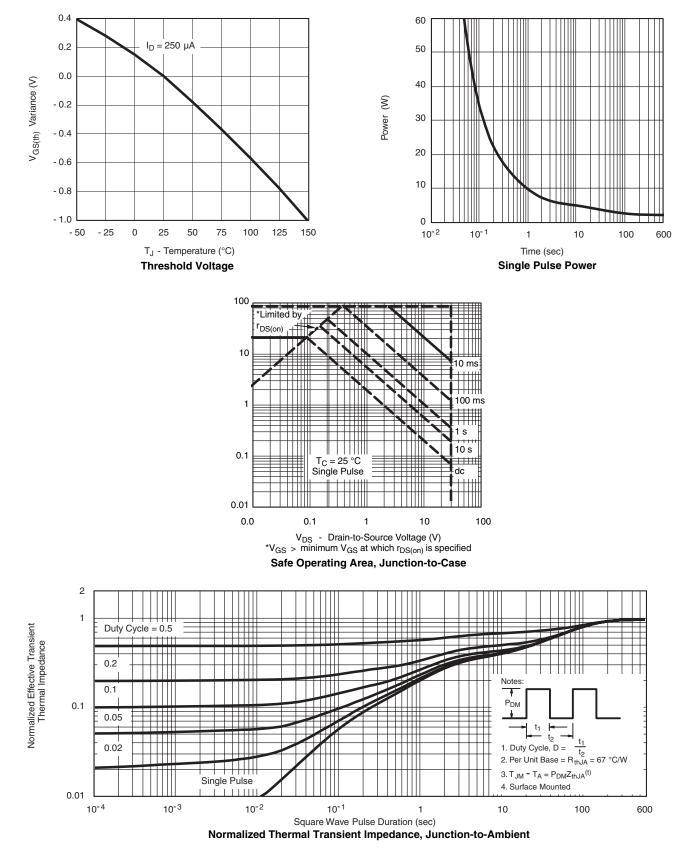
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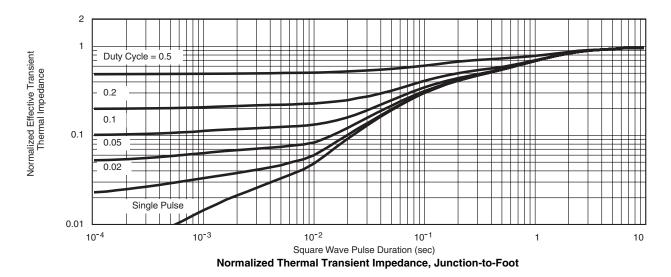
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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